

Electron Probe Microanalyzer

EPMA-8050G

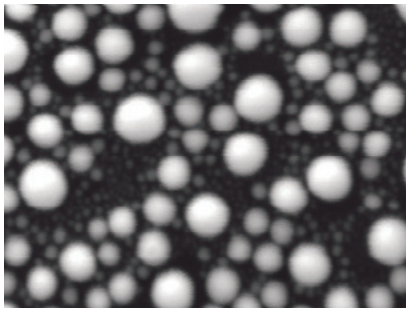


Debut of the Grand EPMA

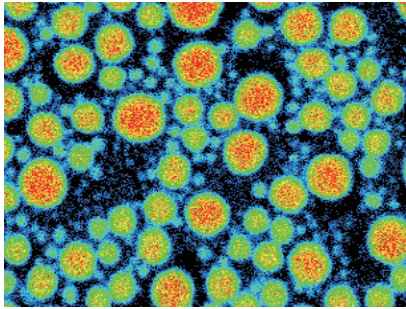
**With a Cutting-Edge FE Electron Optical System,
the Ultimate in Advanced Shimadzu EPMA Analysis Performance**

- ▮ The high brightness schottky emitter deployment
- ▮ Realize a high irradiation electric current and high-resolution coexistence
- ▮ Maintain X-rays takeoff an angle of 52.5 degrees
- ▮ It can carry a high sensitive (4 inches) spectroscope to up to 5ch
- ▮ Incorporate a high illumination optical system





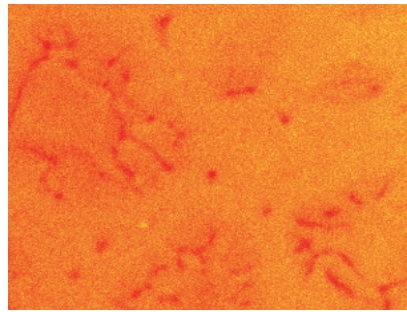
SE 500nm



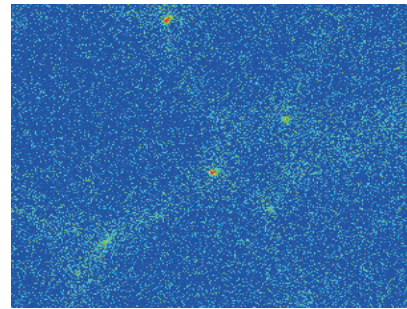
Sn 500nm

Ultra High Resolution Mapping

A mapping analysis of Sn balls on carbon was performed at a magnification of 30,000x. Even Sn particles a mere 50 nm in diameter, visible in the SE image (Upper fig.), can be confirmed precisely in the X-ray image (Lower fig.).



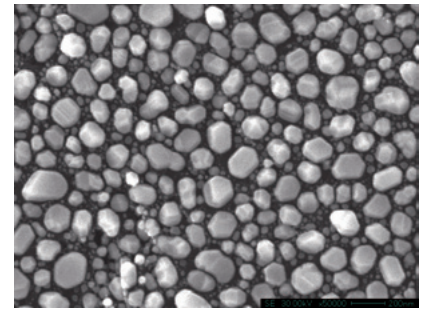
Cr 5 μm



Mn 5 μm

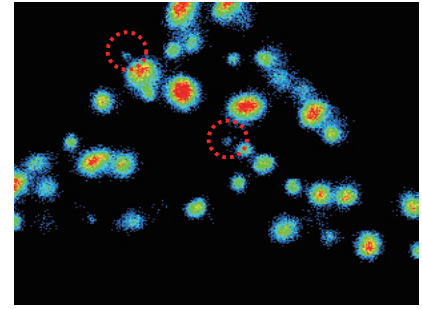
Ultra High Sensitivity Mapping

A mapping analysis of stainless steel was performed with a beam current of 1 μA at a magnification of 5,000x. (Upper fig.) The distribution of phases with slightly different Cr concentrations is precisely captured. (Lower fig.) The system succeeds in visualizing a distribution of Mn content under 0.1 %.



Highest Secondary-Electron Image Resolution of 3 nm

This is a sample observation of gold particle deposition on carbon. A maximum resolution of 3 nm (at 30 kV) is achieved. The beam is focused even at a comparatively large beam current, so a smooth, high-resolution SEM image is easily obtained.



Ag 1 μm

Applications : Distribution of Ag in Lead-Free Sold

This data is from a mapping analysis of areas in lead-free solder containing a large amount of Ag. (Accelerating voltage: 10 kV; beam current: 20 nA) It is evident that the particles with a diameter of about 0.1 μm, indicated by the red dashed lines, are also Ag particles.



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